

Barry Brennan

List of Publications by Year in descending order

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70
papers

2,802
citations

236833

25
h-index

182361

51
g-index

70
all docs

70
docs citations

70
times ranked

4339
citing authors

#	ARTICLE	IF	CITATIONS
1	Using nuclear magnetic resonance proton relaxation to probe the surface chemistry of carbon 2D materials. <i>Nanoscale</i> , 2021, 13, 6389-6393.	2.8	8
2	Gas Cluster Ion Beam Cleaning of CVD-Grown Graphene for Use in Electronic Device Fabrication. <i>ACS Applied Nano Materials</i> , 2021, 4, 5187-5197.	2.4	5
3	Understanding the bonding mechanisms of organic molecules deposited on graphene for biosensing applications. <i>Journal of Chemical Physics</i> , 2021, 155, 174703.	1.2	3
4	Oxidising and carburising catalyst conditioning for the controlled growth and transfer of large crystal monolayer hexagonal boron nitride. <i>2D Materials</i> , 2020, 7, 024005.	2.0	13
5	Integrated Wafer Scale Growth of Single Crystal Metal Films and High Quality Graphene. <i>ACS Nano</i> , 2020, 14, 13593-13601.	7.3	23
6	Nanoscale characterization of plasma functionalized graphitic flakes using tip-enhanced Raman spectroscopy. <i>Journal of Chemical Physics</i> , 2020, 153, 184708.	1.2	14
7	Understanding metal organic chemical vapour deposition of monolayer WS ₂ : the enhancing role of Au substrate for simple organosulfur precursors. <i>Nanoscale</i> , 2020, 12, 22234-22244.	2.8	13
8	Mechanical properties of the hollow-wall graphene gyroid lattice. <i>Acta Materialia</i> , 2020, 201, 254-265.	3.8	10
9	Gas physisorption measurements as a quality control tool for the properties of graphene/graphite powders. <i>Carbon</i> , 2020, 167, 585-595.	5.4	16
10	Determining the Level and Location of Functional Groups on Few-Layer Graphene and Their Effect on the Mechanical Properties of Nanocomposites. <i>ACS Applied Materials & Interfaces</i> , 2020, 12, 13481-13493.	4.0	27
11	Reactive intercalation and oxidation at the buried graphene-germanium interface. <i>APL Materials</i> , 2019, 7, .	2.2	16
12	The Role and Control of Residual Bulk Oxygen in the Catalytic Growth of 2D Materials. <i>Journal of Physical Chemistry C</i> , 2019, 123, 16257-16267.	1.5	21
13	Unusual oxidation-induced core-level shifts at the HfO ₂ /InP interface. <i>Scientific Reports</i> , 2019, 9, 1462.	1.6	9
14	Physicochemical characterisation of reduced graphene oxide for conductive thin films. <i>RSC Advances</i> , 2018, 8, 37540-37549.	1.7	14
15	Structural, chemical and electrical characterisation of conductive graphene-polymer composite films. <i>Applied Surface Science</i> , 2017, 403, 403-412.	3.1	25
16	Physical, chemical and electrical characterisation of the diffusion of copper in silicon dioxide and prevention via a CuAl alloy barrier layer system. <i>Materials Science in Semiconductor Processing</i> , 2017, 63, 227-236.	1.9	11
17	Understanding and Controlling Cu-Catalyzed Graphene Nucleation: The Role of Impurities, Roughness, and Oxygen Scavenging. <i>Chemistry of Materials</i> , 2016, 28, 8905-8915.	3.2	128
18	In Situ XPS Chemical Analysis of MnSiO ₃ Copper Diffusion Barrier Layer Formation and Simultaneous Fabrication of Metal Oxide Semiconductor Electrical Test MOS Structures. <i>ACS Applied Materials & Interfaces</i> , 2016, 8, 2470-2477.	4.0	32

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19	Effect of disorder on Raman scattering of single-layer MoS_2 . Physical Review B, 2015, 91, .	1.1	553
20	Nucleation Control for Large, Single Crystalline Domains of Monolayer Hexagonal Boron Nitride via Si-Doped Fe Catalysts. Nano Letters, 2015, 15, 1867-1875.	4.5	139
21	Removal of Organic Contamination from Graphene with a Controllable Mass-Selected Argon Gas Cluster Ion Beam. Journal of Physical Chemistry C, 2015, 119, 17836-17841.	1.5	24
22	Probing individual point defects in graphene via near-field Raman scattering. Nanoscale, 2015, 7, 19413-19418.	2.8	35
23	Quantitative characterization of defect size in graphene using Raman spectroscopy. Applied Physics Letters, 2014, 105, .	1.5	61
24	Diffusion of In _{0.53} Ga _{0.47} As elements through hafnium oxide during post deposition annealing. Applied Physics Letters, 2014, 104, .	1.5	23
25	Silicon Interfacial Passivation Layer Chemistry for High- κ /InP Interfaces. ACS Applied Materials & Interfaces, 2014, 6, 7340-7345.	4.0	14
26	GaSb oxide thermal stability studied by dynamic-XPS. Journal of Vacuum Science and Technology B: Nanotechnology and Microelectronics, 2014, 32, 041201.	0.6	18
27	Electrical and chemical characteristics of Al ₂ O ₃ /InP metal-oxide-semiconductor capacitors. Applied Physics Letters, 2013, 102, 132903.	1.5	37
28	Interfacial graphene growth in the Ni/SiO ₂ system using pulsed laser deposition. Applied Physics Letters, 2013, 103, 134102.	1.5	20
29	HfO ₂ on MoS ₂ by Atomic Layer Deposition: Adsorption Mechanisms and Thickness Scalability. ACS Nano, 2013, 7, 10354-10361.	7.3	237
30	The Characterization and Passivation of Fixed Oxide Charges and Interface States in the $\text{Al}_2\text{O}_3/\text{InGaAs}$ MOS System. IEEE Transactions on Device and Materials Reliability, 2013, 13, 429-443.	1.5	43
31	Surface and interfacial reaction study of half cycle atomic layer deposited HfO ₂ on chemically treated GaSb surfaces. Applied Physics Letters, 2013, 102, .	1.5	25
32	Investigation of arsenic and antimony capping layers, and half cycle reactions during atomic layer deposition of Al ₂ O ₃ on GaSb(100). Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films, 2013, 31, .	0.9	10
33	Measurement of Schottky barrier height tuning using dielectric dipole insertion method at metal-semiconductor interfaces by photoelectron spectroscopy and electrical characterization techniques. Journal of Vacuum Science and Technology B: Nanotechnology and Microelectronics, 2013, 31, .	0.6	14
34	Impact of N ₂ and forming gas plasma exposure on the growth and interfacial characteristics of Al ₂ O ₃ on AlGaN. Applied Physics Letters, 2013, 103, .	1.5	29
35	Low-Temperature Atomic-Layer-Deposited High- κ Dielectric for p-Channel In _{0.7} Ga _{0.3} As/GaAs _{0.35} Sb _{0.65} Heterojunction Tunneling Field-Effect Transistor. Applied Physics Express, 2013, 6, 101201.	1.1	8
36	In situ study of the role of substrate temperature during atomic layer deposition of HfO ₂ on InP. Journal of Applied Physics, 2013, 114, 154105.	1.1	14

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37	Surface and interfacial reaction study of InAs(100)-crystalline oxide interface. Applied Physics Letters, 2013, 102, .	1.5	14
38	<i>In situ</i> atomic layer deposition study of HfO ₂ growth on NH ₄ OH and atomic hydrogen treated Al _{0.25} Ga _{0.75} N. Journal of Applied Physics, 2013, 113, .	1.1	14
39	<i>In situ</i> study of e-beam Al and Hf metal deposition on native oxide InP (100). Journal of Applied Physics, 2013, 114, .	1.1	9
40	<i>In situ</i> study of atomic layer deposition Al ₂ O ₃ on GaP (100). Applied Physics Letters, 2013, 103, 121604.	1.5	10
41	<i>In situ</i> study of HfO ₂ atomic layer deposition on InP(100). Applied Physics Letters, 2013, 102, .	1.5	19
42	Chemical and electrical characterization of the HfO ₂ /InAlAs interface. Journal of Applied Physics, 2013, 114, .	1.1	22
43	Atomic hydrogen cleaning of In _{0.53} Ga _{0.47} As studied using synchrotron radiation photoelectron spectroscopy. Physica Status Solidi - Rapid Research Letters, 2013, 7, 989-992.	1.2	2
44	Optimization of the ammonium sulfide (NH ₄) ₂ S passivation process on InSb(111)A. Journal of Vacuum Science and Technology B: Nanotechnology and Microelectronics, 2012, 30, 04E103.	0.6	23
45	Investigation of interfacial oxidation control using sacrificial metallic Al and La passivation layers on InGaAs. Journal of Vacuum Science and Technology B: Nanotechnology and Microelectronics, 2012, 30, 04E104.	0.6	6
46	In situ atomic layer deposition half cycle study of Al ₂ O ₃ growth on AlGaIn. Applied Physics Letters, 2012, 101, 211604.	1.5	37
47	Interfacial oxide re-growth in thin film metal oxide III-V semiconductor systems. Applied Physics Letters, 2012, 100, .	1.5	47
48	<i>In situ</i> surface pre-treatment study of GaAs and In _{0.53} Ga _{0.47} As. Applied Physics Letters, 2012, 100, .	1.5	28
49	(S)TEM analysis of the interdiffusion and barrier layer formation in Mn/Cu heterostructures on SiO ₂ for interconnect technologies. Journal of Physics: Conference Series, 2012, 371, 012037.	0.3	2
50	In situ X-ray photoelectron spectroscopy characterization of Al ₂ O ₃ /InSb interface evolution from atomic layer deposition. Applied Surface Science, 2012, 258, 5522-5525.	3.1	10
51	<i>In situ</i> X-ray photoelectron spectroscopy of trimethyl aluminum and water half cycle treatments on HF treated and O ₃ oxidized GaN substrates. Physica Status Solidi - Rapid Research Letters, 2012, 6, 22-24.	1.2	22
52	A systematic study of (NH ₄) ₂ S passivation (22%, 10%, 5%, or 1%) on the interface properties of the Al ₂ O ₃ /In _{0.53} Ga _{0.47} As/InP system for n-type and p-type In _{0.53} Ga _{0.47} As epitaxial layers. Journal of Applied Physics, 2011, 109, .	1.1	113
53	Synchrotron radiation photoemission study of in situ manganese silicate formation on SiO ₂ for barrier layer applications. Applied Physics Letters, 2011, 98, 113508.	1.5	33
54	High resolution photoemission study of the thermal stability of the HfO ₂ /SiO _x /Si(111) system. Surface Science, 2011, 605, 1925-1928.	0.8	1

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55	Investigation of Tunneling Current in $\text{SiO}_2/\text{HfO}_2$ Gate Stacks for Flash Memory Applications. IEEE Transactions on Electron Devices, 2011, 58, 4189-4195.	1.6	5
56	Optimisation of the ammonium sulphide $(\text{NH}_4)_2\text{S}$ passivation process on $\text{In}_{0.53}\text{Ga}_{0.47}\text{As}$. Applied Surface Science, 2011, 257, 4082-4090.	3.1	71
57	Interdiffusion and barrier layer formation in thermally evaporated Mn/Cu heterostructures on SiO_2 substrates. Applied Physics Letters, 2011, 98, 123112.	1.5	38
58	Effect of post deposition anneal on the characteristics of HfO_2/InP metal-oxide-semiconductor capacitors. Applied Physics Letters, 2011, 99, .	1.5	51
59	<i>In-situ</i> characterization of Ga_2O_3 passivation of $\text{In}_{0.53}\text{Ga}_{0.47}\text{As}$ prior to high-k dielectric atomic layer deposition. Applied Physics Letters, 2011, 99, .	1.5	15
60	High-k Oxide Growth on III-V Surfaces: Chemical Bonding and MOSFET Performance. ECS Transactions, 2011, 35, 403-413.	0.3	6
61	Surface and Interfacial Reaction Study of Half Cycle Atomic Layer Deposited Al_2O_3 on Chemically Treated InP Surfaces. Applied Physics Express, 2011, 4, 125701.	1.1	36
62	Photoemission studies of the initial interface formation of ultrathin MgO dielectric layers on the $\text{Si}(111)$ surface. Thin Solid Films, 2010, 518, 1980-1984.	0.8	11
63	Identification and thermal stability of the native oxides on InGaAs using synchrotron radiation based photoemission. Journal of Applied Physics, 2010, 108, .	1.1	80
64	$(\text{NH}_4)_2\text{S}$ Passivation of High-k/ $\text{In}_{0.53}\text{Ga}_{0.47}\text{As}$ Interfaces: A Systematic Study of $(\text{NH}_4)_2\text{S}$ Concentration. ECS Transactions, 2010, 28, 231-238.	0.3	6
65	High resolution photoemission study of $\text{SiO}_x/\text{Si}(111)$ interface disruption following in situ HfO_2 deposition. Applied Physics Letters, 2009, 95, 072903.	1.5	4
66	Half-Cycle Atomic Layer Deposition Reaction Study Using O_3 and H_2O Oxidation of Al_2O_3 on $\text{In}_{0.53}\text{Ga}_{0.47}\text{As}$. Electrochemical and Solid-State Letters, 2009, 12, H205.	2.2	34
67	Growth, ambient stability and electrical characterisation of MgO thin films on silicon surfaces. Microelectronic Engineering, 2009, 86, 1711-1714.	1.1	26
68	Detection of Ga suboxides and their impact on III-V passivation and Fermi-level pinning. Applied Physics Letters, 2009, 94, .	1.5	250
69	In situ H_2S passivation of $\text{In}_{0.53}\text{Ga}_{0.47}\text{As}/\text{InP}$ metal-oxide-semiconductor capacitors with atomic-layer deposited HfO_2 gate dielectric. Applied Physics Letters, 2008, 92, 022902.	1.5	49
70	Photoemission studies of the interface formation of ultrathin MgO dielectric layers on the oxidised $\text{Si}(111)$ surface. Journal of Physics: Conference Series, 2008, 100, 042047.	0.3	16